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(54) **DISPLAY PANEL AND MANUFACTURING METHOD THEREOF**

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(57) **ABSTRACT**

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A display panel and a manufacturing method thereof are provided. The display panel comprises a first substrate, a driving circuit layer disposed on a side of the first substrate, a light-emitting device layer disposed on a side of the driving circuit layer away from the first substrate, a second substrate disposed on a side of the light-emitting device layer away from the driving circuit layer, and a stress releasing layer disposed on a side of the second substrate close to the light-emitting device layer. The stress releasing layer is disposed corresponding to the non-display region, and a concave section is disposed in the stress releasing layer.

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